

CONFIGURABLE MULTIPLE-FUNCTION GATE

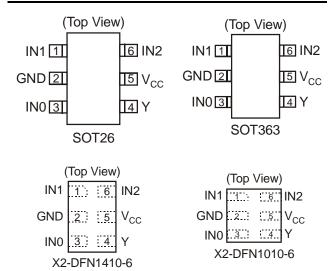
Description

The 74LVC1G58 is a single 3-input positive configurable multiple function gate with a standard push-pull output. The output state is determined by eight patterns of 3-bit input. The user can chose the logic functions AND, OR, NAND, NOR, XOR, inverter or non-inverting buffer. All inputs can be connected to ground or Vcc as required. The device is designed for operation with a power supply range of 1.65V to 5.5V. The inputs are tolerant to 5.5V allowing this device to be used in a mixed voltage environment. The device is fully specified for partial power down applications using IOFF. The IOFF circuitry disables the output preventing damaging current backflow when the device is powered down. The user is reminded that the device can simulate several types of logic gates, but may respond differently due to the Schmitt action at the inputs.

Features

- Wide Supply Voltage Range from 1.65V to 5.5V
- ± 24mA Output Drive at 3.3V
- · CMOS low power consumption
- IOFF Supports Partial-Power-Down Mode Operation
- · Inputs accept up to 5.5V
- ESD Protection Exceeds JESD 22
 - 200-V Machine Model (A115-A)
 - 2000-V Human Body Model (A114-A)
- Latch-Up Exceeds 100mA per JESD 78, Class II
- Range of Package Options
- SOT26, SOT363, DF1410, and DFN1010: Available in "Green" Molding Compound (no Br, Sb)
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Pin Assignments



Applications

- Voltage Level Shifting
- General Purpose Logic
- · Power Down Signal Isolation
- · Wide array of products such as:
 - PCs, networking, notebooks, netbooks, PDAs
 - Computer peripherals, hard drives, CD/DVD ROM
 - TV, DVD, DVR, set top box
 - Cell Phones, Personal Navigation / GPS
 - MP3 players .Cameras. Video Recorders

Notes:

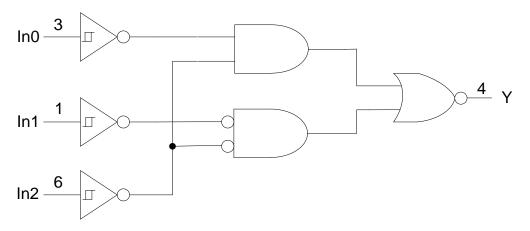
- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



Pin Descriptions

Pin Name	Function
IN1	Data Input
GND	Ground
IN0	Data Input
Υ	Data Output
Vcc	Supply Voltage
IN2	Data Input

Logic Diagram

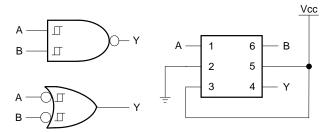


Function Table

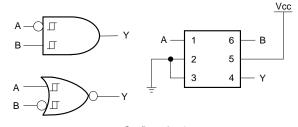
	Inputs	Output	
IN2	IN1	IN0	Υ
L	L	L	L
L	┙	Н	Н
L	Н	L	L
L	Н	Н	Н
Н	┙	L	Н
Н	L	Н	Н
Н	Н	L	L
Н	Н	Н	L



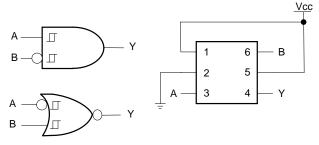
Logic Configurations



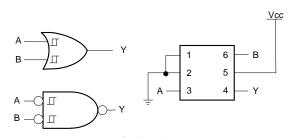
Configuration 1
2-Input NAND Gate
2-Input OR Gate with Both Inputs Inverted



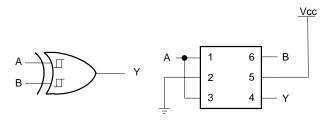
Configuration 2 2-Input AND Gate with A Input Inverted 2-Input NOR Gate with B input Inverted



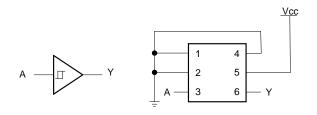
Configuration 3 2-Input AND Gate with B Input Inverted 2-Input NOR Gate with A Input Inverted



Configuration 4
2-Input OR Gate
2-Input NAND Gate with Both Inputs Inverted



Configuration 5 2-Input XOR Gate



Configuration 6 Buffer

Function Selection Table							
Logic Function	Configuration						
2-input NAND	1						
2-input NAND with both inputs inverted	4						
2-input AND with inverted input	2, 3						
2-input NOR with inverted input	2, 3						
2-input OR	4						
2-input OR with both inputs inverted	1						
2-input XOR	5						
1-input Buffer	6						



Absolute Maximum Ratings (Note 4)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD MM	Machine Model ESD Protection	200	V
Vcc	Supply Voltage Range	-0.5 to 6.5	V
Vı	Input Voltage Range	-0.5 to 6.5	V
Vo	Voltage applied to output in high impedance or IOFF state	-0.5 to 6.5	V
Vo	Voltage applied to output in high or low state	-0.3 to Vcc +0.5	V
lıĸ	Input Clamp Current V _I < 0	-50	mA
lok	Output Clamp Current	-50	mA
lo	Continuous output current	±50	mA
	Continuous current through Vdd or GND	±100	mA
T_J	Operating Junction Temperature	-40 to +150	°C
Tstg	Storage Temperature	-65 to +150	°C

Note:

Recommended Operating Conditions (Note 5)

Symbol		Parameter	Min	Max	Unit
Vaa	Operating Voltage	Operating	1.65	5.5	V
Vcc	Operating Voltage	Data retention only	1.5		V
Vı	Input Voltage		0	5.5	V
Vo	Output Voltage		0	Vcc	V
		V _{CC} = 1.65V		-4	
	High-level output current	Vcc = 2.3V		-8	mA
Іон		Vcc = 3V		-16	
				-24	
		Vcc = 4.5V		-32	
		Vcc = 1.65V		4	
		V _{CC} = 2.3V		8	
loL	Low-level output current), av		16	mA
		Vcc = 3V		24	
		V _{CC} = 4.5V		32	
TA	Operating free-air temperature		-40	+125	°C

Note: 5. Unused inputs should be held at V_{CC} or Ground.

^{4.} Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.



Electrical Characteristics T_A = -40°C to +85°C (All typical values are at V_{CC} = 3.3V, T_A = +25°C)

Symbol	Parameter	Test Conditions	Vcc	Min	Тур	Max	Unit
			1.65V	0.70		1.20	
			2.3V	1.11		1.60	
V _{T+}	Positive-going input threshold voltage		3V	1.50		2.00	
	tilleshold voltage		4.5V	2.16		2.74	
			5.5V	2.61		3.33	
			1.65V	0.30		0.72	
			2.3V	0.58		1.00	
V_{T-}	Negative-going input threshold voltage		3V	0.80		1.30	
	tilleshold voltage		4.5V	1.21		1.95	
			5.5V	1.45		2.35	
			1.65V	0.30		0.62	
			2.3V	0.40		0.80	
ΔV_T	Hysteresis (V _{T+} - V _{T-})		3V	0.35		1.00	
			4.5V	0.55		1.10	
			5.5V	0.60		1.20	
	High Level Output Voltage	Іон = -100μΑ	1.65V to 5.5V	Vcc - 0.1			
		I _{OH} = -4mA	1.65V	1.2			
Vон		Iон = -8mA	2.3V	1.9			V
VOH		Iон = -16mA	3V	2.4			
		I _{OH} = -24mA	3V	2.3			
		Iон = -32mA	4.5V	3.8			
		I _{OL} = 100μA	1.65V to 5.5V			0.1	
		I _{OL} = 4mA	1.65V			0.45	
VoL	High-level Input Voltage	IoL = 8mA	2.3V			0.3	V
VOL	High-level input voltage	I _{OL} = 16mA	3V			0.4	V
		I _{OL} = 24mA	34			0.55	
		I _{OL} = 32mA	4.5			0.55	
lı	Input Current	V _I = 5.5V or GND	0 to 5.5V			± 5	μΑ
loff	Power Down Leakage Current	V_I or $V_O = 5.5V$	0			± 10	μΑ
lcc	Supply Current	V _I = 5.5V of GND I _O =0	1.65V to 5.5V			10	μA
ΔΙσο	Additional Supply Current	One input at Vcc -0.6V Other inputs at Vcc or GND	3V to 5.5V			500	μΑ



Electrical Characteristics T_A = -40°C to +125°C (All typical values are at V_{CC} = 3.3V, T_A = +25°C)

Symbol	Parameter	Test Conditions	Vcc	Min	Тур	Max	Unit
			1.65V	0.70		1.20	
			2.3V	1.11		1.60	
V _{T+}	Positive-going input threshold voltage		3V	1.50		2.00	
	threshold voltage		4.5V	2.16		2.74	
			5.5V	2.61		3.33	
			1.65V	0.30		0.75	
			2.3V	0.58		1.03	
V_{T-}	Negative-going input threshold voltage		3V	0.80		1.33	
	The shold voltage		4.5V	1.21		1.95	
			5.5V	1.45		2.35	
			1.65V	0.30		0.62	
	V⊤ Hysteresis (V⊤+ - V⊤-)		2.3V	0.37		0.80	
ΔV_T			3V	0.32		1.00	
			4.5V	0.50		1.20	
			5.5V	0.55		1.40	
		Іон = -100μΑ	1.65V to 5.5V	Vcc -0.1			
		I _{OH} = -4mA	1.65V	0.95			
\/-··		Iон = -8mA	2.3V	1.7			
Vон	High Level Output Voltage	igh Level Output Voltage IoH = -16mA		1.9			V
		I _{OH} = -24mA	3V	2.0]
		Iон = -32mA	4.5V	3.4			
		I _{OL} = 100μA	1.65V to 5.5V			0.1	
		I _{OL} = 4mA	1.65V			0.7	
	LP ale level level Malta va	IoL = 8mA	2.3V			0.45	
V_{OL}	High-level Input Voltage	IoL = 16mA	2) /			0.6	V
		I _{OL} = 24mA	3V			0.8	
		IoL = 32mA	4.5			0.8	
lı	Input Current	V _I = 5.5V or GND	0 to 5.5V			± 100	μΑ
loff	Power Down Leakage Current	V_I or $V_O = 5.5V$	0			± 200	μA
Icc	Supply Current	V _I = 5.5V of GND Io=0	1.65V to 5.5V			200	μΑ
ΔΙα	Additional Supply Current	One input at Vcc -0.6V Other inputs at Vcc or GND	3V to 5.5V			5000	μА



Electrical Characteristics (All typical values are at Vcc = 3.3V, TA = +25°C)

Symbol	Parameter	Test Conditions	Vcc	Min	Тур	Max	Unit
Cı	Input Capacitance	V _I = V _{CC} – or GND	3.3		3.5		pF
		SOT26			204		
	Thermal Resistance Junction-	SOT363	(Note 6)		371		
θЈΑ	to-Ambient	X2-DFN1410-6			430		°C/W
		X2-DFN1010-6			510		
		SOT26	(Note 6)		52		
	Thermal Resistance Junction-	SOT363			143]
θις	to-Case	X2-DFN1410-6			190		°C/W
		X2-DFN1010-6			250		

Note:

Switching Characteristics

T_A = -40°C to +85°C, CL = 30 or 50pF as noted (see Figure 1)

Parameter	From	то		: 1.8V .15V		: 2.5V).2V		: 3.3V).3V		= 5V .5V	Unit
	(Input)	(OUTPUT)	Min	Max	Min	Max	Min	Max	Min	Max	
t _{pd}	Any	Y	1.0	14.4	0.7	8.3	0.7	6.3	0.7	5.1	ns

 $T_A = -40$ °C to +125°C, CL = 30 or 50pF as noted (see Figure 1)

Parameter	From	TO	V _{CC} = 1.8V ± 0.15V		V _{CC} = 2.5V ± 0.2V		V _{CC} = 3.3V ± 0.3V		V _{CC} = 5V ± 0.5V		Unit
	(Input)	(Input) (OUTPUT)	Min	Max	Min	Max	Min	Max	Min	Max	
t _{pd}	Any	Y	1.0	18.0	0.7	10.4	0.7	7.9	0.7	6.4	ns

Operating Characteristics

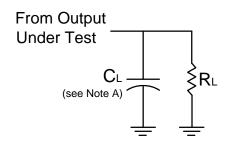
 $T_A = +25^{\circ}C$

Parameter		Test Conditions	V _{CC} = 1.8V Typ.	V _{CC} = 2.5V Typ.	V _{CC} = 3.3V Typ.	V _{CC} = 5V Typ.	Unit
C_{pd}	Power dissipation capacitance	f = 10 MHz	22	22	23	24	pF

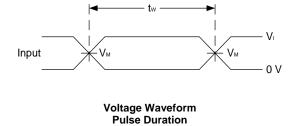
^{6.} Test condition for SOT26, SOT363, X2-DFN1410-6 and X2-DFN1010-6: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

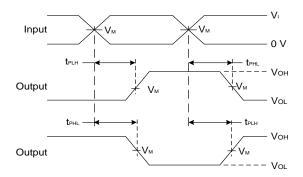


Parameter Measurement Information



Vcc	Inputs		V _M	CL	RL	
100	Vı	t _r /t _f				
1.8V±0.15V	Vcc	≤2ns	Vcc/2	30pF	1ΚΩ	
2.5V±0.2V	Vcc	≤2ns	V _{CC} /2	30pF	500Ω	
3.3V±0.3V	3V	≤2.5ns	1.5V	50pF	500Ω	
5V±0.5V	Vcc	≤2.5ns	Vcc/2	50pF	500Ω	





Voltage Waveform Propagation Delay Times **Inverting and Non Inverting Outputs**

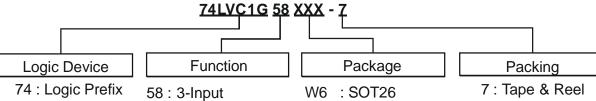
Figure 1. Load Circuit and Voltage Waveforms

Notes:

- A. Includes test lead and test apparatus capacitance. B. All pulses are supplied at pulse repetition rate \leq 10 MHz
- C. Inputs are measured separately one transition per measurement
- D. tplh and tphL are the same as tpD



Ordering Information



LVC: 1.65 to 5.5V Configurable DW: SOT363

Family Multiple-Function FW4: X2-DFN1010-6 1G: One gate Gate FZ4: X2-DFN1410-6

	Davida	Basham Oak	Packaging 7" Tape and Reel		and Reel
	Device	Package Code	(Note 7)	Quantity	Part Number Suffix
en e	74LVC1G58W6-7	W6	SOT26	3000/Tape & Reel	-7
en e	74LVC1G58DW-7	DW	SOT363	3000/Tape & Reel	-7
oon.	74LVC1G58FW4-7	FW4	X2-DFN1010-6	5000/Tape & Reel	-7
	74LVC1G58FZ4-7	FZ4	X2-DFN1410-6	5000/Tape & Reel	-7



Note:

7. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information

(1) SOT26, SOT363

6 5 4

XX Y W X

2 3 XX: Identification code

Y: Year 0~9

W: Week: A~Z: 1~26 week;

a~z: 27~52 week; z represents

52 and 53 week

X: A~Z: Internal Code

Part Number	Package	Identification Code
74LVC1G58W6	SOT26	TX
74LVC1G58DW	SOT363	TX

(2) X2-DFN1010-6, X2-DFN1410-6

(Top View)

XX XX: Identification Code

 $\overline{\underline{Y}}$: Year : 0~9

₩: Week: A~Z: 1~26 week; a~z: 27~52 week; z represents

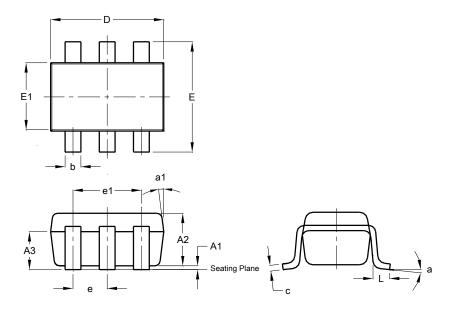
52 and 53 week \underline{X} : A~Z: Internal code

Part Number	Package	Identification Code
74LVC1G58FW4	X2-DFN1010-6	TX
74LVC1G58FZ4	X2-DFN1410-6	TX



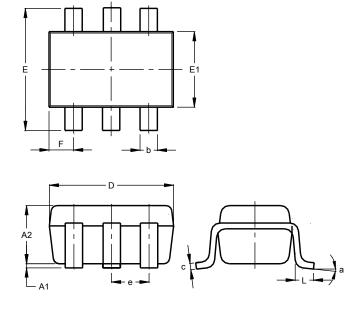
Package Outline Dimensions (All Dimensions in mm)

(1) **SOT26**



SOT26				
Dim	Min	Max	Тур	
A1	0.013	0.10	0.05	
A2	1.00	1.30	1.10	
A3	0.70	0.80	0.75	
b	0.35	0.50	0.38	
С	0.10	0.20	0.15	
D	2.90	3.10	3.00	
е	-	-	0.95	
e1	-	-	1.90	
Е	2.70	3.00	2.80	
E1	1.50	1.70	1.60	
L	0.35	0.55	0.40	
а	-	-	8°	
a1	-	-	7°	
All Dimensions in mm				

(2) SOT363

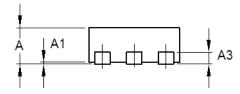


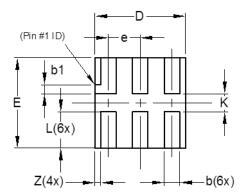
SOT363					
Dim	Min	Max	Тур		
A 1	0.00	0.10	0.05		
A2	0.90	1.00	0.95		
b	0.10	0.30	0.25		
С	0.10	0.22	0.11		
D	1.80	2.20	2.15		
Ε	2.00	2.20	2.10		
E1	1.15	1.35	1.30		
е	C	.650 B	SC		
F	0.40	0.45	0.425		
L	0.25	0.40	0.30		
а	0°	8°			
All Dimensions in mm					



Package Outline Dimensions (All Dimensions in mm)

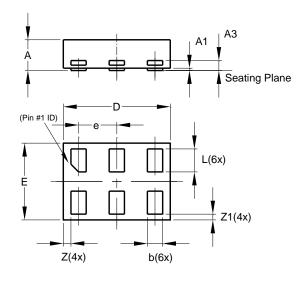
(3) X2-DFN1010-6





X2-DFN1010-6				
Dim	Min	Max	Тур	
Α	_	0.40	0.39	
A 1	0.00	0.05	0.02	
А3	_	_	0.13	
b	0.14	0.20	0.17	
b1	0.05	0.15	0.10	
D	0.95	1.05	1.00	
E	0.95	1.05	1.00	
е	_	_	0.35	
L	0.35	0.45	0.40	
K	0.15	_	_	
Z	_	_	0.065	
All Dimensions in mm				

(4) X2-DFN1410-6

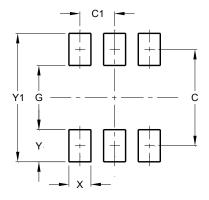


X2-DFN1410-6				
Dim	Min	Max	Тур	
Α		0.40	0.39	
A1	0.00	0.05	0.02	
A3			0.13	
b	0.15	0.25	0.20	
D	1.35	1.45	1.40	
Е	0.95	1.05	1.00	
е		_	0.50	
L	0.25	0.35	0.30	
Z			0.10	
Z 1	0.045	0.105	0.075	
All Dimensions in mm				



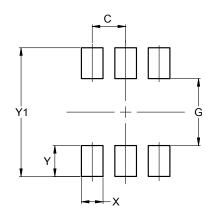
Suggest Pad Layout

(1) SOT26



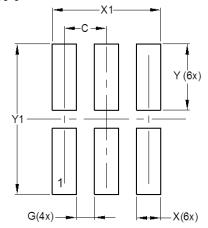
Dimensions	Value (in mm)
С	2.40
C1	0.95
G	1.60
Х	0.55
Y	0.80
Y1	3.20

(2) SOT363



Dimensions	Value (in mm)
С	0.650
G	1.300
Х	0.420
Υ	0.600
Y1	2.500

(3) X2-DFN1010-6

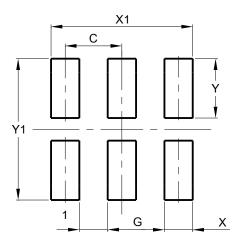


Dimensions	Value (in mm)
С	0.350
G	0.150
X	0.200
X1	0.900
Y	0.550
Y1	1.250



Suggest Pad Layout

(4) X2-DFN1410-6



Dimensions	Value (in mm)
С	0.500
G	0.250
Х	0.250
X1	1.250
Υ	0.525
Y1	1.250



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